

ON-BOARD PLATE/OGP



OGP configuration ensures reliable contact

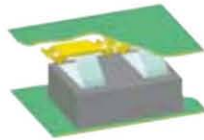
Feature

- OGP solves contact failure problems caused by solder flux.
- Reliable contact is provided at FG reinforcement of PC board.

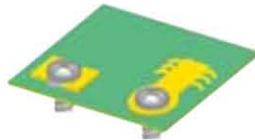
Material

- Brass (OGP-3216 / Au plating , OGP-4520 / Sn reflow plating)

Application examples

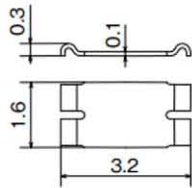


- Effective contact
 - OGP protects PC board from damage such as circuit pattern damage by vibration etc at FG area.
 - Gold plating is available at the required location on PC board.



- Alternative components to washers and lug terminals
 - More compact than conventional lug terminals.
 - OGP prevents loosening of screws when subject to vibration.

OGP-3216



OGP-4520

